DATA SHEET

Mass Flow Controllers



Model GP200 with EtherCAT®

GP200 Series

Metal Sealed, Digital, Ultra-high Purity Pressurebased Mass Flow Controllers for Gases

The GP200 Series is the first fully (both inlet and outlet) pressure insensitive P-MFC, designed specifically for semiconductor applications. The GP200's unique differential pressure technology, coupled with its downstream valve architecture, removes the current limitations of pressure-based mass flow controllers, enabling the most precise process gas delivery over the widest range of operating conditions in the industry.

As the inventor and market leader in gas and flow range programmable Mass Flow Controllers, Brooks sophisticated and proprietary MultiFlo[™] gas model is now embedded within each GP200 device enabling on-the-fly gas & range reconfiguration for maximum process flexibility.

The GP200's ultra-fast, highly repeatable Matched Transient Response and dynamic cross-talk insensitivity enable tighter process control, handling extreme supply pressure variations while maintaining precise mass flow control to the chamber. The GP200 platform supports a broad range of process conditions which enables drop-in replacement and upgrade of many traditional pressure-based mass flow controllers.

Features	Benefits
True Differential Pressure Measurement	By removing the requirement to match and compensate two separate pressure transducers, the GP200 differential pressure technology reduces measurement uncertainty for enhanced accuracy, repeatability and drift performance.
Lower Inlet Pressure Option	Safer fab operation at lower inlet pressures is now achievable with a P-MFC due to the GP200's differential pressure sensor that is specifically optimized for low differential pressure measurement.
Cross-Talk Insentive	Maintains tight process control under dynamic process conditions- the accuracy of the GP200 P-MFC will stay within $\leq \pm$ 1% of S.P. during extreme pressure supply disruptions up to 40 psi/sec
Matched Transient Response	Ultra-fast, highly repeatable ascending and descending flow stabilization time enables tighter process control in advanced high cycle Deposition and Etch processes.
Downstream Value Architecture	The GP200's downstream valve architecture ensures that accuracy is independent of downstream pressure, enabling flow delivery into pressures as high as 1200 Torr. The GP200's fast closing valve addresses non-productive recipe wait times, or "tail effects", that are seen in upstream MFC valve designs that require additional time to bleed down their internal volume of gas.
Zero Leak-by Control Valve	100X improvement in valve shut-down addresses the long standing "first wafer effect" where the accumulation of unmetered gas (between the MFC control valve & downstream isolation valve) contributes to non-uniformities and Critical Dimension (CD) defects on the first wafer of a process.
High Flow Rate Capability	10 sccm to 50 slm F.S. N2 equivalent P-MFC supports all process flow needs with just nine (9) standard bin configurations for maximum flexibility.



Beyond Measure

Product Specifications

Performance							
Full Scale Flow Range 3 sccm to 50,000 sccm F.S. N2 Equivalent							
Process Gas Flow Accuracy ¹	Zero Leak Valve: < ± 1% S.P. (5 – 100% F.S.) < ± 0.05% F.S. (0.5 - 5% F.S.)	Metal Seal Valve: < ± 1% S.P. (5-100% F.S.) < ± 0.05% F.S. (2-5% F.S.)					
Control Range	0.5– 100% F.S.	2– 100% F.S.					
Repeatability & Reproducibility	5-100% = ± 0.15% of S.P. 0.5-5% = ± 0.015% of F.S	5-100% = ± 0.15% of S.P. 2-5% = ± 0.015% of F.S					
Transient Response & Flow Settling Time	280 ± 20 ms Matched Transient Response, for any ascending or descending non-zero setpoint (Fast Response Option available via Customer Special Request.)						
Valve Leak-by	Zero Leak Valve: <0.005% of F.S. of the bin (Bins 42-46) <0.02% of F.S. of the bin (Bins 40-41) (@ 45 psia to VAC)	Metal Seal Valve: <0.15% of F.S. of the bin (@ 45 psia to VAC)					
Supply Pressure Insensitivity/Cross-Talk	< ± 1% S.P. up to 40 ps	i/sec inlet pressure spike					
Steady State Back Pressure Insensitivity	Insensitive to steady	/ state back pressure					
Dynamic Back Pressure Insensitivity	Maintains accuracy during disturbance from	n vacuum to 1200 Torr over a period of 1 sec					
Zero Stability	< ± 0.15%	F.S. per year					
Temperature Coefficient	Zero: 0.005% F.S. per °C Span: 0.05% S.P. per °C						
Number of Standard Configurations	Nine (9) standard bin ranges						
Dynamic Gas and Range Programmability	Device may be configured via single tool command in less than 1 second or via BEST Software with independent USB diagnostic port						
Attitude Insensitivity ¹ For Analog control, adder of < ± 0.05% F.S. applies	Insensitive to device orientation after re-zeroing						
Ratings							
Operating Temperature Range ²	10 –	60°C					
Operating Inlet Pressure ³	< 15 psia for Low Pressure (LP) bins, configurable based on application 15 to 30 psia 25 to 40 psia 35 to 50 psia 45 to 60 psia						
Operating Outlet Pressure ³		Atmosphere r some applications					
Differential Pressure Range	Min: 7 psid typical	Max: up to 50 psid					
External Leak Integrity	1 x 10-10 at	m cc/sec He					
Proof Pressure	100 psia, Standard Gases 70 psia, Helium and Helium Mixtures 45 psia, Low Pressure Gases						
Design Pressure	150 psia						
Burst Pressure) psia					
Burst Pressure Mechanical) psia					
	1000) psia y Closed					
Mechanical	1000 Normali						

² Device should be zeroed at ambient operating temperature per Brooks Instrument recommended procedure

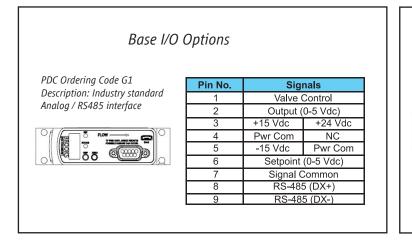
³ Consult Brooks Configurator for specific Product Sizing Options

Product Specifications

Diagnostics & Display						
Status Lights	DeviceNet: MFC Health, Network Status EtherCAT: Run, Error, Power, Network Status, Analog/RS485: Network Status					
Alarms⁴	Process Control Deviations, Flow High/Low, Temperature High/Low, Pressure High/Low, Voltage Input High/Low, Communication Alarms, Hardware Failures, Page Create Errors, Warmup Alarm (alarms are model specific)					
Display Type	Top Mount Integrated LCD					
Viewing Angle/Viewing Distance	Rotatable / 10 ft					
Units Displayed/Resolution	Flow (%), Temp. (°C), Pressure (psia, kPa) / 0.1 (unit)					
Electrical						
Digital Communication	DeviceNet™, EtherCAT®, RS485 (model specific)					
Electrical Connection	DeviceNet™ via 5-Pin M12 connector EtherCAT® via RJ45 jacks, Power via 5-pin M8 connector 0-5V Analog/RS485 (L-Protocol) via 9-pin D-Connector					
Independent Diagnostics Service Port	RS485 via micro-USB					
DeviceNet Power Supply/Consumption	545mA max. @ +11-25 Vdc, 250mA max. @ 24 Vdc (under typical operating conditions)					
EtherCAT Power Supply/Consumption	360mA max @ 18-30 Vdc, 270mA max @ 24 Vdc (under typical operating conditions)					
Analog/RS485 Power Supply/Consumption	6 Watts max @ ± 15 Vdc (± 10%) or +24Vdc (± 10%) (under typical operating conditions)					
Compliance						
EMC	2014/30/EU EMC Directive EN:61326-1: 2013					
Environmental Compliance	2011/65/EU & 2015/863/EU RoHS Directive EC 1907/2006 REACH Directive					

⁴ For full list of alarms available consult GP200 Supplemental Communication Manuals at www.BrooksInstrument.com

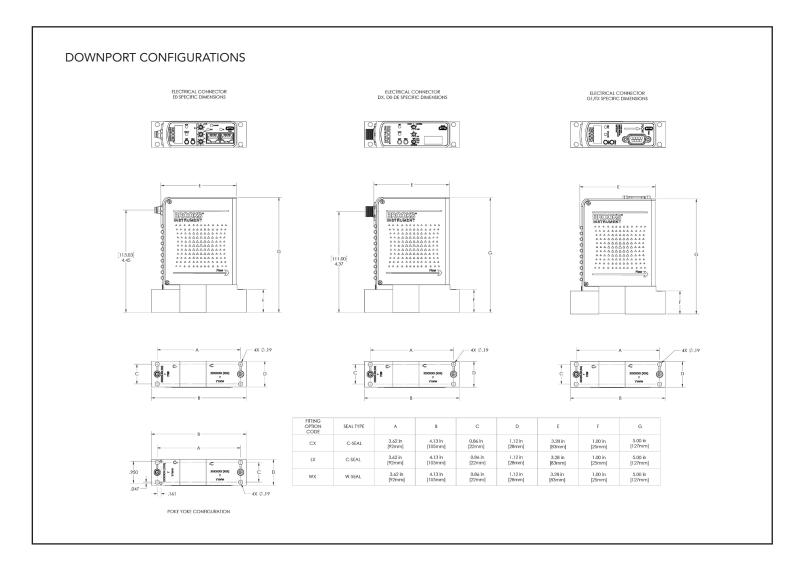
Electrical Interface Options

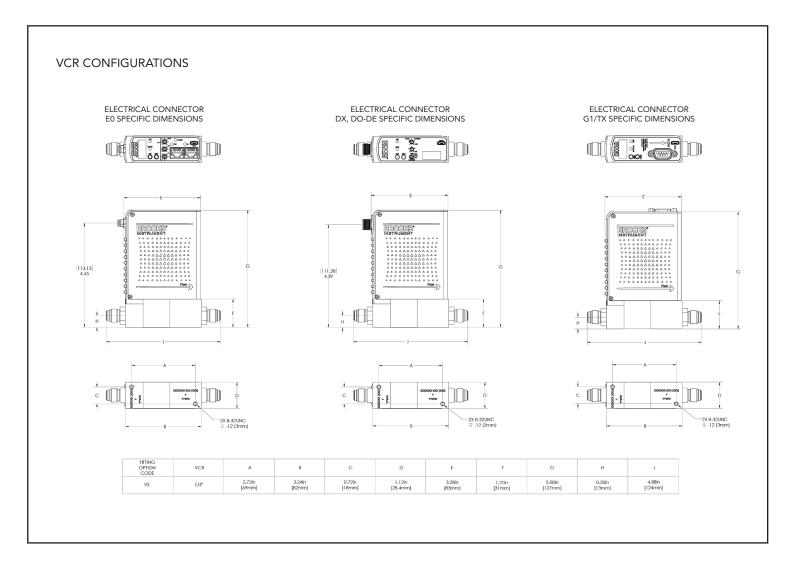


PDC Ordering Code TX Description: Industry standard Analog only interface



Pin No.	Signals						
1	Valve	Control					
2	Output (0-5 Vdc)					
3	+15 Vdc	+24 Vdc					
4	Pwr Com	NC					
5	-15 Vdc	Pwr Com					
6	Setpoint (0-5 Vdc)						
7	Signal Common						
8	No Connection						
9	No Connection						





Model Code

Code	Description	Code Op		tion Desci									
Ι.	Base Model Code	GP20		Ultra-High Purity Pressure-Based Mass Flow Controllers									
11.	Valve Configuration	Р		Positive Shut-off/Zero Leak-by Valve⁵									
	0	С		mally Close			/e Seat						
III.	Gas and Range ⁶	0013 01		ccm F.S. N2				onfiguration	at 35 psia in	let. vacuum	outlet		
	eas and range	0013 03		ccm F.S. N2									
		0013 10		sccm F.S. N									
		0013 30		sccm F.S. N									
		0013 00		0 sccm F.S.				•					
		0013 00		0 sccm F.S.									
		0013 0		00 sccm F.S									
		0013 02				, ,		0		,			
		0013 02	,	25,000 sccm F.S. N2 Equivalent, CT47 Standard Bin Configuration at 35 psia inlet, vacuum outlet 45,000 sccm F.S. N2 Equivalent, CT48 Standard Bin Configuration at 35 psia inlet, vacuum outlet									
1) /	Standard Type (CT) Din	0013 02	,	45,000 sccm F.S. N2 Equivalent, C148 Standard Bin Configuration at 35 psia inlet, vacuum outlet Consult Brooks Configurator or Bin Tables									
IV.	Standard Type (CT) Bin	OTA		5									
		CT40		Standard Bin Configuration #40 Standard Bin Configuration #41									
		CT4											
		CT42		ndard Bin C									
		CT43		ndard Bin C	•								
		CT44		ndard Bin C	0								
		CT45		ndard Bin C									
		CT46		ndard Bin C									
		CT47		ndard Bin C	•								
		CT48		ndard Bin C									
V.	Low Pressure (LP) Bin		LP40 Low Pressure Bin Configuration #40										
			LP41 Low Pressure Bin Configuration #41										
			LP42 Low Pressure Bin Configuration #42										
			LP43 Low Pressure Bin Configuration #43										
		LP44		Low Pressure Bin Configuration #44									
		LP45	5 Low	Pressure E	3in Configu	ration #45	45						
		LP46	6 Low	Pressure E	3in Configu	ration #46							
VI.	Fittings	CX											
		WX	1-1/8" body width, 92mm W-Seal										
		VS	1-1/	1-1/8" body width, 124mm 1/4" VCR male									
		LX	1-1/	8" body wid	th, 92mm (C-Seal w/Pc	ke Yoke						
VII.	Communications/Connector	Quili		Davian						Poll IO	External		
		Code	I/O	Power On State	Full Scale Setting		Producer	Consumer	State	Baud			
		Option					-			Transition	Rate		
		D0	DeviceNet	Idle	Count	Integer	6000h	2	7	Executing	500KB		
		D1	DeviceNet	Idle	Count	Integer	6000h	21	7	Executing	500KB		
		D2	DeviceNet	Idle	SCCM	Float	7FFFh	13	19	Executing	500KB		
		D3	DeviceNet	Idle	Count	Integer	6000h	22	7	Executing	500KB		
		D4	DeviceNet	Executing	Count	Integer	6000h	22	8	Executing	500KB		
		D5	DeviceNet	-	Count	Integer	6000h	6	8	Executing	500KB		
		D6	DeviceNet		Count	Integer	7FFFh	3	7	Executing	500KB		
		D7	DeviceNet		Count	Integer	7FFFh	6	8	Executing	500KB		
		D8	DeviceNet		Count	Integer	6000h	3	7	Executing	500KB		
		D9		Executing	Count	Integer	6000h	2	7	Executing	500KB		
		DA	DeviceNet		Count	Integer	7FFFh	22	7	Executing	500KB		
		DA	DeviceNet		Count	Integer	6000h	22	8	Executing	500KB		
		DD	DeviceNet		Count	Integer	7FFFh	3	7	Idle	500KB		
		DD		Executing		Integer	7FFFh	22	8	Executing	500KB		
		DD		Executing		SCCM	6000h	15	19	Executing			
		DE	DeviceNet		SCOM				ial Request		JUUND		
		DX	Devicemen			IO DE DEIII	ieu by Cus	iomer spec	a Request	•			

⁵ Zero Leak Valve Option not currently available with bins CT47-CT48
⁶ Consult Brooks Configurator or Bin Tables for specific Product Sizing Options

Model Code

Code D	Description	Code Option	Option Description
VII.	Communications/Connector	E0	EtherCAT Communication
		G1	9-Pin D-Connector with Analog/RS485 Communication
		TX	9-Pin D-Connector with Analog Only
VIII.	Customer Special Request	XXXX	Customer Special Request (Consult factory for new requests)
IX.	Minimum Inlet Pressure	15	15 psia minimum inlet pressure, ~15-30 psia inlet pressure range
		25	25 psia minimum inlet pressure, ~25-40 psia inlet pressure range
		35	35 psia minimum inlet pressure, ~35-50 psia inlet pressure range
		45	45 psia minimum inlet pressure, ~45-60 psia inlet pressure range
Х.	Downstream Condition	V	Vacuum
		А	Atmosphere
		Р	Positive Pressure (760 Torr up to 1200 Torr)
XI.	Auto Shut-off	А	Auto Shut Off (Included)
		Х	Auto Shut Off (Not Included)
XII.	Reference Temperature	00C	0°C Reference Calibration (Standard)

Example Model Code

			IV	V	VI	VII	VIII	IX	Х	XI
GP200	С	0013003L	CT45	СХ	E0	XXXX	35	V	А	00C

Request a Quote

Service and Support

Brooks is committed to assuring all of our customers receive the ideal flow solution for their application, along with outstanding service and support to back it up. We operate first class repair facilities located around the world to provide rapid response and support. Each location utilizes primary standard calibration equipment to ensure accuracy and reliability for repairs and recalibration and is certified by our local Weights and Measures Authorities and traceable to the relevant International Standards.

Visit www.BrooksInstrument.com to locate the service location nearest to you.

START-UP SERVICE AND IN-SITU CALIBRATION

Brooks Instrument can provide start-up service prior to operation when required. For some process applications, where ISO-9001 Quality Certification is important, it is mandatory to verify and/or (re)calibrate the products periodically. In many cases this service can be provided under in-situ conditions, and the results will be traceable to the relevant international quality standards.

CUSTOMER SEMINARS AND TRAINING

Brooks Instrument can provide customer seminars and dedicated training to engineers, end users, and maintenance persons. Please contact your nearest sales representative for more details. Due to Brooks Instrument's commitment to continuous improvement of our products, all specifications are subject to change without notice.

TRADEMARKS BrooksBrooks Instrument, LLC All other trademarks are the property of their respective owners.



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